Half-mount type with 0.85mm installed height above the PC board

Typical Specifications



Water-proof Dust-proof	R
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	Pi

Items	Specifications
Rating (max.)	50mA 12V DC
Rating (min.)	10µA 1V DC
Initial contact resistance	500mΩ max.
Travel (mm)	0.15
Protective structure *	IP67 equivalent

# Product Line

Product No.	Operating force	Operating direction	Operating life	Minimum order unit (pcs.)		
FIOUUGENO.			(5mA 5V DC)	Japan	Export	
SKTGLBE010	1.6N	Side push	200,000 cycles	5,500	5,500	

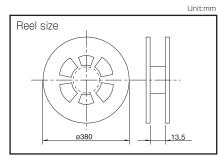
# Packing Specifications

Taping

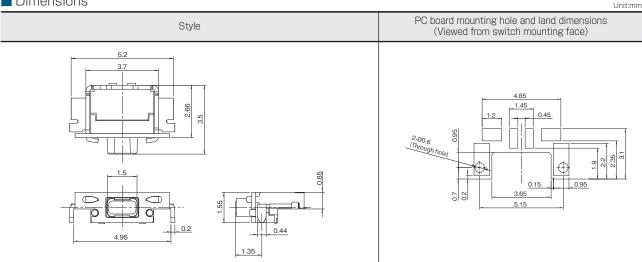
Number of packages (pcs.)			Tape width	Export package
1 reel	1 case / Japan	1 case / export packing	(mm)	measurements (mm)
5,500	55,000	55,000	12	395×395×205

#### Note

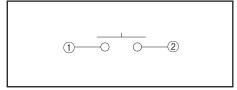
For reels of 330mm diameter, please inquire.



# Dimensions



# Circuit Diagram



\* Assumes the switch is left alone without being operated. Under the specified conditions, dust and water ingress with a significant impact on the switch's on-off function is prevented.

IP67-level dust and water resistance is guaranteed for the switch alone and performance may not be guaranteed depending on the mounting conditions and usage.

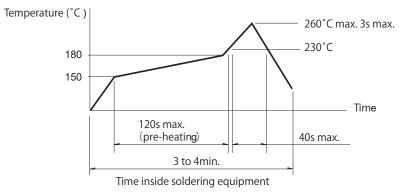


	Туре					eling Type e Mount			
	Series	SKST	SKRA	SKHM	SKHU	SKTD	SKSN	SKTG	SKSL
	Photo		0	19			1		6
	Features	Middle	e travel		-	Low-profile	Mid-mount	Half-m	nount
	Water-proof	Wildle			0				lount
	· .	—		—		•	—	•	_
	Dustproof	_	0	_	0	•	_	•	_
	IP standard	—	67 equivalent	_	_	67 equivalent	—	67 equivalent	_
Operatir		•	•	•	•	_		—	—
directio	n Side push	—	_	—	_	•	•	•	•
	W	□8.5	□6.2	6.2	6.2	3.9	6.2	5.2	4.5
Dimensio (mm)	D D	0.5	0.z	6.5	6.3	2.9	3	3.5	2.6
	H	3.95	3.5/5.2	3.1	2.5/3.1	1.55	3.5	1.55	2.2
Operatio force coverag	2N to 3N	4N to 10N	Ţ	Ţ	Ţ	\$	Î	<b>\$</b>	ţ
	Travel (mm)	0.9	See the relevant pages for respective product description	0.	25	0.15	0.2	0.1	5
G	round terminal	_	_	•	•	•	•	•	٠
Operating temperature range		-40℃ t	:o +90℃	-40℃ 1	:o +85℃	−30℃ to +85℃	−40℃ to +85℃	-30°C to	o +85℃
A	utomotive use	•	0	_	•	_	0	_	0
	Life Cycle		*3						
	Rating (max.) (Resistive load)	50mA 16V DC				50mA 12V DC			
Electrical	Rating (min.) (Resistive load)	10µA 1V DC							
performance	Insulation resistance	100MΩ min. 100V DC 1min.							
	Voltage proof		250V A	C 1min.		100V AC 1min.	250V A	AC 1min.	100V AC 1min.
	Vibration		10 to \$	55 to 10Hz/m	nin., the amplitu	ude is 1.5mm fo nd Z for 2 hours	r all the freque	encies,	
Durability	Lifetime					th individual spe			
	Cold	-40°C 1,000h -40°C 96h							
nvironmental	Dry heat	90°C .	1,000h	90°C	; 96h	85°C 96h	90°C 96h	85°C 96h	90°C 961
performance	Damp heat		C, 90 to 95%RH 1,000h			60°C, 90 to 95%RH 96h			
	Page	216	217	218	219	221	222	223	224
ACT Sw	itch <sup>™</sup> Soldering Con	ditions · · ·			 D H	/ : Width. The ma : Depth. The ma : Height. The m	ost outer dimer ost outer dimer inimum dimens	nsion excluding t nsion excluding t sion if there are v	terminal por terminal por variances.

Notes

/LPS/LPINE

Condition for Reflow Available for Surface Mount Type. Temperature profile



## Notes

1. Please confirm the specifications of our product for the detailed condition.

2. Soldering conditions differ depending on reflow soldering machines.

Prior verification of soldering condition is highly recommended.

## Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

#### **SKHH Series**

ltems	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110 $^\circ\!\mathrm{C}$ max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHL Top Push Type, SKQJ Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

#### Notes

1. Prevent flux penetration from the top side of the TACT Switch<sup>TM</sup>.

2. Switch terminals and a PC board should not be coated with flux prior to soldering.

3. The second soldering should be done after the switch is stable with normal temperature.

4. Use the flux with a specific gravity of min 0.81.

(EC-195-8 by TAMURA CORPORATION, or equivalents.)

## Manual Soldering

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

#### SKHH, SKHW Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

### SKTD, SKTG, SKQJ, SKSN Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.